CTLSH1-40M832D

SURFACE MOUNT DUAL, HIGH CURRENT LOW V_{F} SILICON SCHOTTKY RECTIFIERS



• Device is Halogen Free by design

APPLICATIONS:

- DC/DC Converters
- Reverse Battery Protection
- Battery Powered Portable Equipment

Central semiconductor corp.

www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CTLSH1-40M832D Dual, Isolated, Low V_F Silicon Schottky rectifiers are designed for applications where small size and operational effciency are the prime requirements. With a maximum power dissipation of 1.65W, and a very small package footprint (approximately equal to the SOT-23), this leadless package design is capable of dissipating up to 4 times the power of similar devices in comparable sized surface mount packages.

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FEATURES:

- High Current (I_F=1.0A)
- Low Forward Voltage Drop (V_F=0.55V MAX @ 1.0A)
- High Thermal Efficiency
- Small TLM 3x2mm case

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	40	V
Continuous Forward Current	I _F	1.0	Α
Peak Repetitive Forward Current, tp≤1.0ms	I _{FRM}	3.5	Α
Peak Forward Surge Current, tp=8.0ms	I _{FSM}	10	Α
Power Dissipation (Note 1)	P_{D}	1.65	W
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance (Note 1)	Θ_{JA}	75.8	°C/W

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I_R	V _R =5.0V			10	μΑ
I_R	V _R =8.0V			20	μΑ
I_R	V _R =15V			50	μΑ
I_R	V _R =40V			0.2	mA
I_R	V _R =40V, T _A =100°C			20	mA
BV_R	I _R =100μA	40			V
V _F	I _F =10mA			0.29	V
V_{F}	I _F =100mA			0.36	V
VF	I _F =500mA			0.45	V
V_{F}	I _F =1.0A			0.55	V
CJ	V _R =4.0V, f=1.0MHz		50		pF

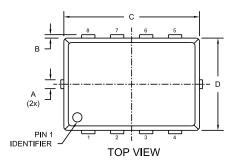
Notes: (1) FR-4 Epoxy PC Board with copper mounting pad area of 54mm²

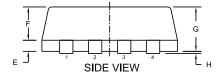
CTLSH1-40M832D

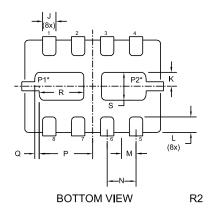
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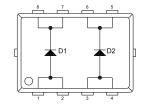
TLM832D CASE - MECHANICAL OUTLINE







- * Note:
- Exposed pad P1 common to pins 7 and 8 Exposed pad P2 common to pins 5 and 6

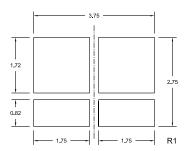


DIMENSIONS				
	INCHES		MILLIM	ETERS
SYMBOL	MIN	MAX	MIN	MAX
Α	0.007	0.012	0.170	0.300
В	-	0.005	-	0.125
С	0.114	0.122	2.900	3.100
D	0.075	0.083	1.900	2.100
Е	0.006	0.010	0.150	0.250
F	0.026	0.030	0.650	0.750
G	0.031	0.039	0.800	1.000
Н	0.000	0.002	0.000	0.050
J	0.009	0.013	0.240	0.340
K	0.006	0.014	0.160	0.360
L	0.008	0.018	0.200	0.450
М	0.013		0.3	325
Ν	0.026		0.650	
Р	0.040	0.048	1.010	1.210
Q	0.004		0.1	00
R	0.032	0.040	0.820	1.020
S	0.017	0.025	0.430	0.630
TI M832D (PE\/: P2\				

TLM832D (REV: R2)

SUGGESTED MOUNTING PADS For Maximum Power Dissipation

(Dimensions in mm)



For standard mounting refer to TLM832D Package Details

LEAD CODE:

1) Anode D1	5) Cathode D2
2) Anode D1	6) Cathode D2
3) Anode D2	7) Cathode D1
4) Anode D2	8) Cathode D1

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R4 (19-February 2010)